AMPMODU | Modu Connector System

TE Internal #: 1-534236-0

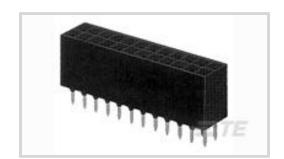
PCB Mount Receptacle, Vertical, Board-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Gold, Through Hole - Solder, Signal, Modu

Connector System

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 20
Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	20
Number of Rows	2
Board-to-Board Configuration	Parallel

Electrical Characteristics

Body Features

Connector Profile	Standard
Primary Product Color	Black

Contact Features

Contact Protection Type	Closed Entry Housing
Mating Square Post Dimension	.64 mm[.025 in]



	150 μin
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Socket
Contact Current Rating (Max)	2 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.69 mm[.027 in]
Termination Post & Tail Length	3.04 mm[.12 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Mating Entry Location	Тор
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Polyester - GF
Dimensions	
Connector Height	8.64 mm[.198 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	10.92 mm[.43 in]
PCB Thickness (Recommended)	1.4 – 2.4 mm[.055 – .094 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Board Standoff



Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	22
Packaging Method	Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Receptacle, Vertical, Board-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Gold, Through Hole - Solder, Signal, Modu Connector System





TE Part # 1-826632-0 10P AMPMODU II PIN HDR.



TE Part # 1-826656-0 10P AMPMODU II STIFT LEI

Also in the Series | Modu Connector System



Automotive Connector Caps & Covers
(3)



Automotive Housings(1)



Board-to-Board Jumpers & Shunts(5)



Connector Caps & Covers(1)



Connector Hardware(4)



PCB Headers & Receptacles(1244)



Standard Edge Connectors(1)

Customers Also Bought



TE Part #CV7361-000 202K132-25L-0



TE Part #HDP24-24-35PE REC, 35P, BLK, E, 16/20, P

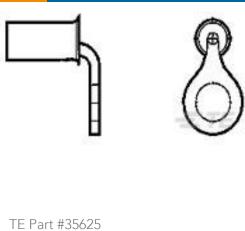


TE Part #36915 TERMINAL, SOLIS R 1/0 1/4





TE Part #3-1393247-4 W31-X2M1G-2=W23/W31



TE Part #35625 TERMINAL, SOLIS R 90DEG 4 1/4





PCB Mount Receptacle, Vertical, Board-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Gold, Through Hole - Solder, Signal, Modu Connector System



TE Part #5-1532004-0 033-0240-0001=ADAPTER,S-93RCP

Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-534236-0_W.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-534236-0_W.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-534236-0_W.3d_stp.zip

English

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Product Specifications

Application Specification

English